

Product Change Notification - CSI0500069 - JAON-08AHID607

Date:

27 Mar 2020

Product Category:

Linear Regulators

Affected CPNs:



Notification subject:

CCB 1737.10 Final Notice: Release to production of listed Micrel Regulator product type manufactured with the CSI05 process technology to Microchip Fab.

Notification text:

PCN Status:

Final Notification

Note: This final PCN only pertains to the products listed in this PCN. Additional final PCNs may be issued for this combination of product type and process technology.

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Release to production of listed Micrel Regulator product type manufactured with the CSI05 process technology to Microchip Fab.

NOTE: Please review the FAQ linked here for additional information about this change.

Pre Change:

Fabricated at Micrel fabrication site (San Jose, CA, USA) using 6 inch wafers.

Post Change:

Fabricated at Microchip fabrication site using 8 inch wafers.

Pre and Post Change Summary:

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	Pre Change	Post Change
	Micrel fabrication site	
Fab Site		Microchip fabrication site
	(San Jose, CA, USA)	
Wafer Size	6 inch wafers	8 inch wafers

Impacts to Data Sheet:

None

Reason for Change:

To improve productivity with the closure of the Micrel fab as part of the integration of Micrel and Microchip.

Change Implementation Status:

In Progress

Estimated First Ship Date:

Estimated First Ship Date (EFSD) are identified for each catalog part numbers (CPN) listed in the attached parts list. This can be found in the attachments field below labeled as PCN_#_Affected_CPN.

Summary Time Table of notable events to date:



		2	01			->			201	6		->)20		M	ay 20	20	
Workweek	36	37	38	39	40		35	36	37	38	39		10	11	12	13	14	18	19	20	21	22
Initial PCN																						
Issue Date																						
	Χ																					
CYER-																						
31JLEX869																						
Qual Report																						
Available																						
										Χ												
JAON-																						
08AHID607																						
Final PCN																						
Issue Date																						
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JAON-																Χ						
08AHID607-																						
CSI0500069																						
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First Ship																			attac			
Date																			hed			
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Markings to Distinguish Revised from Unrevised Devices:

Traceability code and shipping label see <u>FAQ</u>.

Revision History:

September 1, 2015: Issued initial notification as PCN number CYER-31JLEX869.

September 25, 2016: Issued intermediate notification as PCN number <u>JAON-08AHID607</u>. Attached the Qualification Report. Revised the estimated first ship date (EFSD) to inform that the EFSD will be revealed in the final PCN.

March 27, 2020: Issued final notification as PCN number JAON-08AHID607-CSI0500069 for listed Micrel Regulator product manufactured with the CSI05 process technology. Provided estimated first ship date (EFSD) for each CPN listed in the attached parts list.

The change described in this PCN does not alter Micrel's or Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_JAON-08AHID607-CSI0500069_Affected_CPN.pdf PCN_JAON-08AHID607-CSI0500069_Qual_Report.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to receive Microchip PCNs via email please register for our PCN email service at our



<u>PCN home page</u> select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.

If you wish to <u>change your PCN profile, including opt out,</u> please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

JAON-08AHID607 - CCB 1737.10 Final Notice: Release to production of listed Micrel Regulator product type manufactured with the CSI05 process technology to Microchip Fab.
Affected Catalog Part Numbers (CPN)
MIC5364-3.3YMT-TR
Date: Thursday, March 26, 2020

JAON-08AHID607-CSI0500069 - CCB 1737.10 Final Notice: Release to production of listed Micrel Regulator product type manufactured with the CSI05 process technology to Microchip Fab.

Affected Catalog Part Numbers (CPN)

PCN_JAON-	08AHID607-CSI0500069					
CATALOG_PART_NBR Estimated First Ship Date (EFSD)						
MIC5364-3.3YMT-TR	May 08, 2020					



QUALIFICATION REPORT SUMMARY RELIABILITY LABORATORY

PCN #: JAON-08AHID607-CSI0500069

Date September 20, 2016

Qualification of Microchip 8 inch Fabrication site for Micrel products manufactured with the CSI05 Process Technology.

PART NUMBER	PACKAGE TYPE	ASSEMBLY LOCATION	FAB LOCATION	PROCESS NAME
MIC23250-S4YMT-TR	DFN22-10L	UNISEM, IPOH, MALAYSIA	MICROCHIP FAB-2 TEMPE AZ.	CSI 0.5

DIE QUALIFICATION RESULTS

TEST DESCRIPTION	METHOD/CONDITIONS	DATE CODE	LOT ID.	168 HR Rej/ss	500 HR Rej/ss	1000 HR Rej/ss	COMMENTS
HTOL	JESD22, Method 108	1609	V216328088.100MQB	0/77	0/77	0/77	
High Temperature Operating Life Test	Ta = + 125°C	1606	V216328088.000MQJ	0/77	0/77	0/77	
Operating Life 1650	Vcc = +5.5V	1606	V216328088.000MQK	0/77	0/77	0/77	

ELECTROSTATIC DISCHARGE

TEST DESCRIPTION	METHOD/CONDITIONS	DATE CODE	LOT ID.	STRESS	RESULT Rej/ss	COMMENTS
ESD-HBM Human Body Model ATE Test @ Room +25C	R= 1500 Ohms C= 100 pF 1X +/- Voltage	1609	V216328088.100MQB	+/-2000V	0/3	Note: ESD ratings are device specific. All Products qualified on the 8" Micrel process technologies will
ESD-CDM Charged Device Model ATE Test @ Room +25C	JESD22-C101 1X +/- Voltage	1609	V216328088.100MQB	+/-1500V	0/3	have the same or better ESD and Latch-up performance as the 6" San Jose Products.
TEST DESCRIPTION	METHOD/CONDITIONS	DATE CODE	LOT ID.	STRESS	RESULT Rej/ss	COMMENTS
LATCH-UP	JESD-78 TA = +25°C	1609	V216328088.100MQB	I/O LU O/V LU	0/6 0/6	

PACKAGE QUALIFIC				,	
TEST DESCRIPTION	METHOD/CONDITIONS	DATE CODE	LOT ID.	Rej/ss	COMMENTS
		1609	V216328088.100MQB	0/323	
Level 1 Pre-conditioning Flow	JESD22-A113	1606	V216328088.000MQJ	0/143	
		1606	V216328088.000MQK	0/143	
TEST DESCRIPTION	METHOD/CONDITIONS	DATE CODE	LOT ID.	96 HR Rej/ss	COMMENTS
PRESSURE POT	JESD22-A102	1609	V216328088.100MQB	0/45	
With Level 1 Pre- conditioning	Ta = +121°C/100%RH	1606	V216328088.000MQJ	0/45	
Tpeak + 260°C 3X Reflow	15 PSIG	1606	V216328088.000MQK	0/45	
TEST DESCRIPTION	METHOD/CONDITIONS	DATE CODE	LOT ID.	96 HR Rej/ss	COMMENTS
HAST	JESD22-A110 (BIASED)	1609	V216328088.100MQB	0/45	
With Level 1 Pre- conditioning	Ta= +130°C/85%RH	1606	V216328088.000MQJ	0/45	
Tpeak + 260°C 3X Reflow	Vcc = +5.5V	1606	V216328088.000MQK	0/45	
TEST DESCRIPTION	METHOD/CONDITIONS	DATE CODE	LOT ID.	500 CY Rej/ss	COMMENTS
TEMP CYCLE	JESD22-A104	1609	V216328088.100MQB	0/45	
With Level 1 Pre-	Ta = -65°C / +150°C	1606	V216328088.000MQJ	0/45	
conditioning Tpeak + 260°C 3X Reflow		1606	V216328088.000MQK	0/45	
TEST DESCRIPTION	METHOD/CONDITIONS	DATE CODE	LOT ID.	1000 HR Rej/ss	COMMENTS
HTSL					
High Temperature	JESD22-A103	1609	V216328088.100MQB	0/76	
Storage Life With Level 1 Pre- conditioning Tpeak + 260°C 3X Reflow	Ta = +150°C				
E	UL-94V-0	All mold c	ompounds used by Micrel m	neet this stand	ard. See the UL website on-line list of
FLAMMABILITY	Certified	material fl assembly	ammability certifications. M house and we verify the cer	icrel requires a tifications on t	a Certificate of Compliance from the he web.